



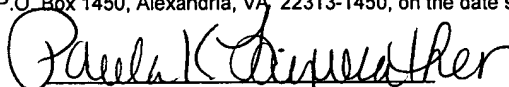
Docket No.: A0312.70491US00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Alan W. Righter  
Serial No.: 10/694675  
Confirmation No.: 4241  
Filed: October 28, 2003  
For: INTEGRATED CIRCUIT BOND PAD STRUCTURES  
AND METHODS OF MAKING  
Examiner: C. Q. Nguyen  
Art Unit: 2811

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: **MS Amendment**, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Dated: November 10, 2005

  
Paula K. Fairweather

**AMENDMENT**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed July 14, 2005, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 8 of this paper.